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PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3505760

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MAURIZIO GRANATO	08/31/2015
GIOVANNI FRATTINI	08/27/2015
PIETRO GIANNELLI	08/27/2015

RECEIVING PARTY DATA

Name:	TEXAS INSTRUMENTS INCORPORATED
Street Address:	12500 TI BOULEVARD, M/S 3999
City:	DALLAS
State/Country:	TEXAS
Postal Code:	75243

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	14840183

CORRESPONDENCE DATA

Fax Number: (214)567-2228

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 214-479-1243 Email: uspto@ti.com

TEXAS INSTRUMENTS INCORPORATED **Correspondent Name:**

Address Line 1: P O BOX 655474, M/S 3999 Address Line 4: DALLAS, TEXAS 75265

ATTORNEY DOCKET NUMBER:	TI-75641
NAME OF SUBMITTER:	ERIC HIGHMAN
SIGNATURE:	/Eric Highman/
DATE SIGNED:	08/31/2015

Total Attachments: 4

source=TI-75641_assignment_US#page1.tif source=TI-75641_assignment_US#page2.tif source=TI-75641 assignment US#page3.tif source=TI-75641 assignment US#page4.tif

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made.

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 12500 TI Boulevard, M/S 3999, Dallas, Texas 75243, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon, as well as to U.S. Provisional Application No(s)._______, filed ______;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign unto the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in and to the said application(s) and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Patent and Trademark Office to issue all patents for said invention, or patents resulting therefrom, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my corresponding rights to the invention disclosed in said application in all other countries of the world, including the right to claim priority, file applications and obtain patents under the terms of the Paris Convention for the Protection of Industrial Property, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

I authorize the later insertion of the nonprovisional application number and filing date hereinbelow.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE	MULTILEVEL BOOST DC TO DC CONVERTER CIRCUIT		
NONPROVISIONAL APPLICATION NO.	14/840,183	FILING DATE	August 31, 2015

SIGNATURE OF INVENTOR	1 9/b.
PRINTED NAME OF INVENTOR	Maurizio Granato
DATE	AUGUST 31, 2015
RESIDENCE (CITY AND STATE)	Via della Capinera 6 Milano, 20147 ITALY

Application No. 14/840,183

Attorney Docket No. TI-75641

SIGNATURE OF INVENTOR	Groce Freth.
PRINTED NAME OF INVENTOR	Giovanni Frattini
DATE	August 27th, 2015
RESIDENCE (CITY AND STATE)	Via Po 84/6 Travaco' Siccomario (PV), 27020 ITALY
SIGNATURE	

SIGNATURE OF INVENTOR	
PRINTED NAME OF INVENTOR	Pietro Giannelli
DATE	·
RESIDENCE (CITY AND STATE)	Via S. Lavagnini 77 Antella (FI), 50012 ITALY

After recording, return Assignment to:

Texas Instruments Incorporated 12500 TI Boulevard (M/S 3999) Dallas, Texas 75243

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I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my corresponding rights to the invention disclosed in said application in all other countries of the world, including the right to claim priority, file applications and obtain patents under the terms of the Paris Convention for the Protection of Industrial Property, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such rights.

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SIGNATURE OF INVENTOR	lu cu:
PRINTED NAME OF INVENTOR	Pietro Giannelli
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> PATENT REEL: 036456 FRAME: 0045

RECORDED: 08/31/2015